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#10/25/01
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In re Application of

Kikuta, K.

Serial No.: 09/584,739

Group Art Unit: 2814

Filed: June 1, 2000

Examiner: Quach, T.

For: COPPER-ALLOY INTERCONNECTION LAYER

Honorable Assistant Commissioner of Patents
Washington, D.C. 20231

**RESPONSE TO FIRST OFFICE ACTION AND RESTRICTION
REQUIREMENT**

Sir:

In response to the Office Action dated September 27, 2001, please consider the following:

REMARKS

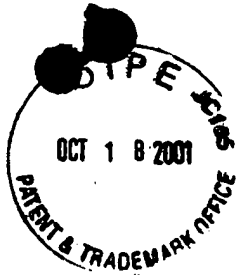
In response to the Examiner's restriction requirement, Applicant hereby elects the invention of Group I (e.g., drawn to a semiconductor device as defined by claims 1-37), without traverse. Applicant reserves the opportunity to file a Divisional Application for the non-elected invention later.

Further, Applicant respectfully requests the Examiner's acknowledgment of the priority document filed on September 14, 2000.

Early, favorable prosecution on the merits is respectfully requested.

Should the Examiner find the application to be other than in condition for allowance, the Examiner is requested to contact the undersigned at the local telephone number listed below to discuss any other changes deemed necessary in a telephonic or personal interview.

09/584,739
PF-2622/NEC/us/mh



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OCT 22 2001

A conditional petition is made for any extension of time which may become necessary. TECHNOLOGY CENTER 2800

The Commissioner is authorized to charge any fees for such extension and to credit any overpayment in fees to Attorney's Deposit Account No. 50-0481.

Respectfully Submitted,

A handwritten signature in black ink, appearing to read "Sean M. McGinn".

Sean M. McGinn

Reg. No. 34,386

Date:

10/18/01
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